

HM6147H Series ——— Maintenance Only

4096-word x 1-bit High Speed CMOS Static RAM

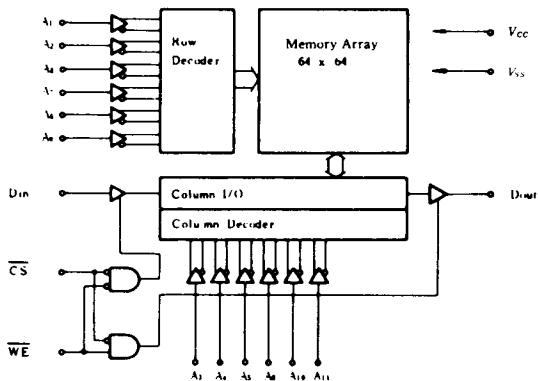
■FEATURES

- High Speed: Fast Access Time 35ns/45ns/55ns (max.)
- Low Power Standby and Low Power Operation,
Standby: 100 μ W (typ.)/5 μ W (typ.) (L-version),
Operation: 150mW typ.
- Single 5V Supply and High Density 18 Pin Package
- Completely Static Memory — No Clock nor Timing Strobe Required
- No Peak Power—On Current
- No Change of t_{ACS} with Short Chip Deselect Time
- Equal Access and Cycle Time
- Directly TTL Compatible — All Input and Output
- Separate Data Input and Output: Three State Output
- Plug-In Replacement with Intel 2147H NMOS STATIC RAM
- Capability of Battery Back Up Operation (L-version)

■ORDERING INFORMATION

Type No.	Access Time	Package
HM6147HP-35	35ns	300mil 18pin Plastic DIP
HM6147HP-45	45ns	
HM6147HP-55	55ns	
HM6147HLP-35	35ns	
HM6147HLP-45	45ns	
HM6147HLP-55	55ns	

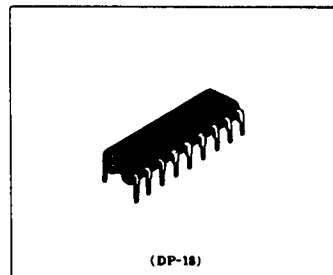
■BLOCK DIAGRAM



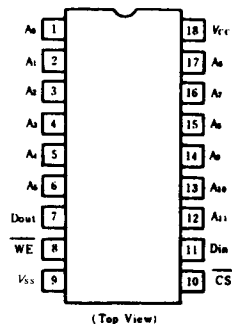
■ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on Any Pin relative to V _{SS}	V _T	-0.5*1 to +7.0	V
DC Output Current	I _O	20	mA
Power Dissipation	P _T	1.0	W
Operating Temperature	T _{OP}	0 to +70	°C
Storage Temperature under bias	T _{STG(bias)}	-10 to +85	°C
Storage Temperature	T _{STG}	-55 to +125	°C

Note) *1 -3.5V for pulse width $\leq$ 20ns



■PIN ARRANGEMENT



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■ RECOMMENDED DC OPERATING CONDITIONS ($0^{\circ}\text{C} \leq T_a \leq 70^{\circ}\text{C}$)

Parameter	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}	4.5	5.0	5.5	V
	V_{SS}	0	0	0	V
Input High (logic 1) Voltage	V_{IH}	2.0	3.0	6.0	V
Input Low (logic 0) Voltage	V_{IL}	-0.5^{*1}	—	0.8	V

Note) *1. -3.0V for pulse width $\leq 20\text{ns}$

■ DC AND OPERATING CHARACTERISTICS ($0^{\circ}\text{C} \leq T_a \leq 70^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}$)

Parameter	Symbol	Test Condition	min	typ*2	max	Unit
Input Leakage Current	$ I_{LI} $	$V_{CC} = 5.5\text{V}$, V_{SS} to V_{CC}	—	—	10	μA
Output Leakage Current	$ I_{LO} $	$\overline{\text{CS}} = V_{IH}$, $V_{in} = V_{SS}$ to V_{CC}	—	—	10	μA
Operating Power Supply Current (1)	I_{CC}	$\overline{\text{CS}} = V_{IL}$, Output open	—	30	80	mA
Operating Power Supply Current (2)	I_{CC1}	$\overline{\text{CS}} = V_{IL}$, Minimum Cycle	—	40	80	mA
Standby Power Supply Current (1)	I_{SB}	$\overline{\text{CS}} = V_{IH}$, $V_{CC} = \text{Min to Max}$	—	8	20	mA
			—	5^{*3}	15^{*3}	
Standby Power Supply Current (2)	I_{SB1}	$\text{CS} \geq V_{CC} - 0.2\text{V}$, $V_{IN} \geq 0.2\text{V}$ or $V_{IN} \geq V_{CC} - 0.2\text{V}$	—	20	800	μA
			—	1^{*3}	100^{*3}	
Output Low Voltage	V_{OL}	$I_{OL} = 8\text{mA}$	—	—	0.40	V
Output High Voltage	V_{OH}	$I_{OH} = -4\text{mA}$	2.4	—	—	V

Notes) *1. The operating ambient temperature range is guaranteed with transverse air flow exceeding 400 linear feet minute.

*2. Typical limits are at $V_{CC} = 5.0\text{V}$, $T_a = 25^{\circ}\text{C}$ and Specified loading.

*3. This characteristics are guaranteed only for L-version.

■ CAPACITANCE ($T_a = 25^{\circ}\text{C}$, $f = 1.0\text{MHz}$)

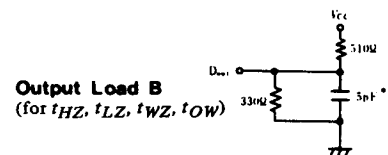
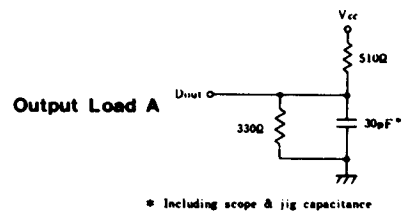
Item	Symbol	Conditions	max	Unit
Input Capacitance	C_{in}	$V_{in} = 0\text{V}$	5	pF
Output Capacitance	C_{out}	$V_{out} = 0\text{V}$	6	pF

Note) This parameter is sampled and not 100% tested.

■ AC CHARACTERISTICS ($T_a = 0$ to $+70^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$)

● AC TEST CONDITIONS

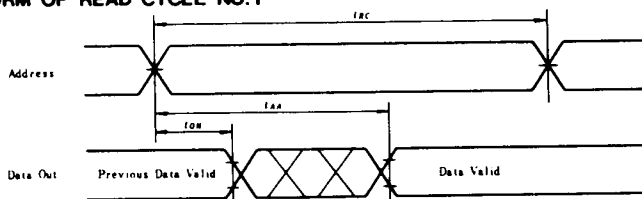
- Input pulse levels: V_{SS} to 3.0V
- Input rise and fall times: 5ns
- Input timing reference levels: 1.5V
- Output load: See Figure
- Output timing reference levels: 1.5V (HM6147H-35)
 0.8 to 2.0V (HM6147H-45/55)



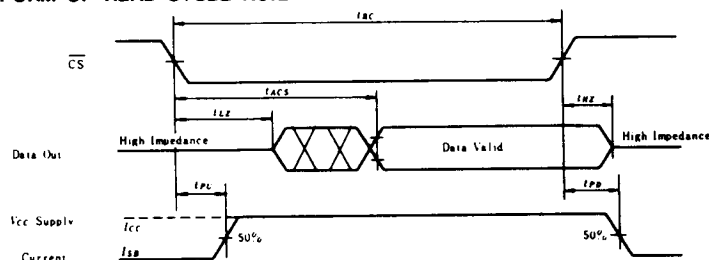
● READ CYCLE

Parameter	Symbol	HM6147H-35		HM6147H-45		HM6147H-55		Unit	Notes
		min	max	min	max	min	max		
Read Cycle Time	t_{RC}	35	—	45	—	55	—	ns	(1)
Address Access Time	t_{AA}	—	35	—	45	—	55	ns	
Chip Select Access Time	t_{ACS}	—	35	—	45	—	55	ns	
Output Hold from Address Change	t_{OH}	5	—	5	—	5	—	ns	
Chip Selection to Output in Low Z	t_{LZ}	5	—	5	—	5	—	ns	(2), (3), (7)
Chip Deselection to Output in High Z	t_{HZ}	0	30	0	30	0	30	ns	(2), (3), (7)
Chip Selection to Power Up Time	t_{PU}	0	—	0	—	0	—	ns	
Chip Deselection to Power Down Time	t_{PD}	—	20	—	20	—	20	ns	

● TIMING WAVEFORM OF READ CYCLE NO.1 (4) (5)



● TIMING WAVEFORM OF READ CYCLE NO.2 (4) (6)



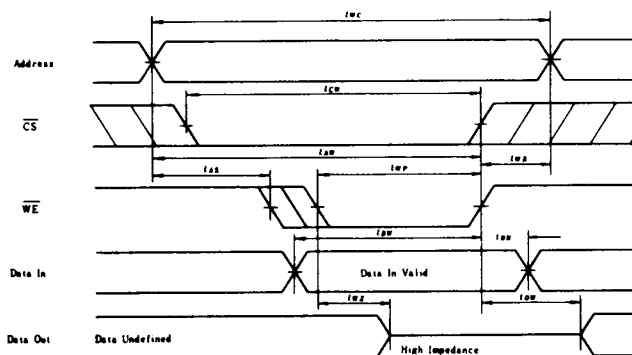
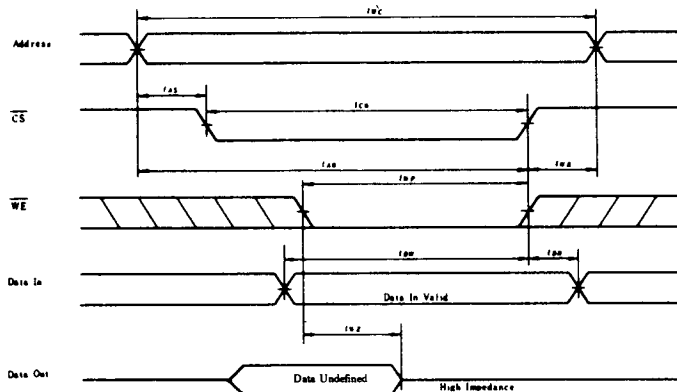
- Notes:
1. All Read Cycle timings are referenced from last valid address to the first transitioning address.
 2. At any given temperature and voltage condition, t_{HZ} max. is less than t_{LZ} min. both for a given device and from device to device.
 3. Transition is measured $\pm 500\text{mV}$ from steady state voltage with specified loading in Load B.
 4. $\overline{CS}$ is high for READ Cycle.
 5. Device is continuously selected, $\overline{CS} = V_{IL}$.
 6. Addresses valid prior to or coincident with $\overline{CS}$ transition low.
 7. This parameter is sampled and not 100% tested.



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● WRITE CYCLE

Parameter	Symbol	HM6147H-35		HM6147H-45		HM6147H-55		Unit	Notes
		min	max	min	max	min	max		
Write Cycle Time	t_{wc}	35	—	45	—	55	—	ns	(2)
Chip Selection to End of Write	t_{cw}	35	—	45	—	45	—	ns	
Address Valid to End of Write	t_{aw}	35	—	45	—	45	—	ns	
Address Setup Time	t_{as}	0	—	0	—	0	—	ns	
Write Pulse Width	t_{wp}	20	—	25	—	30	—	ns	
Write Recovery Time	t_{wr}	0	—	0	—	0	—	ns	
Data Valid to End of Write	t_{dw}	20	—	25	—	25	—	ns	
Data Hold Time	t_{dh}	10	—	10	—	10	—	ns	
Write Enabled to Output in High Z	t_{wz}	0	20	0	25	0	30	ns	(3), (4)
Output Active from End of Write	t_{ow}	0	—	0	—	0	—	ns	(3), (4)

● TIMING WAVEFORM OF WRITE CYCLE ($\overline{WE}$ Controlled)● TIMING WAVEFORM OF WRITE CYCLE ($\overline{CS}$ Controlled)

- Notes:
1. If $\overline{CS}$ goes high simultaneously with $\overline{WE}$ high, the output remains in a high impedance states.
 2. All Write Cycle timings are referenced from the last valid address to the first transitioning address.
 3. Transition is measured $\pm 500\text{mV}$ from steady state voltage with specified loading in Load B.
 4. This parameter is sampled and not 100% tested.
 5. $\overline{CS}$ or $\overline{WE}$ is high for address transition.



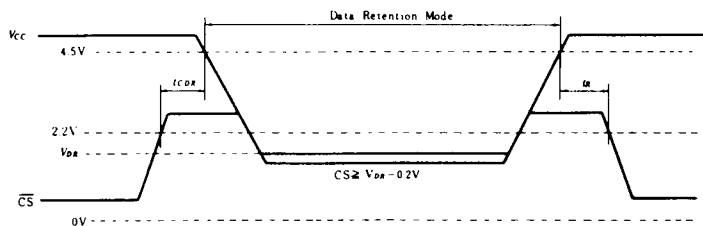
■ LOW V_{CC} DATA RETENTION CHARACTERISTICS ($T_a = 0^\circ\text{C}$ to $+70^\circ\text{C}$)

This characteristics are guaranteed only for L-version.

Item	Symbol	Test Condition	min	typ	max	Unit
V_{CC} for Data Retention	V_{DR}	$\overline{CS} \geq V_{CC} - 0.2\text{V}$ $V_{IN} \geq V_{CC} - 0.2\text{V}$ or $V_{IN} \leq 0.2\text{V}$	2.0	—	—	V
Data Retention Current	I_{CCDR}	$V_{CC} = 3.0\text{V}$, $\overline{CS} \geq 2.8\text{V}$ $V_{IN} \geq 2.8\text{V}$ or $V_{IN} \leq 0.2\text{V}$	—	—	50	μA
Chip Deselect to Data Retention Time	t_{CDR}	See Retention Waveform	0	—	—	ns
Operation Recovery Time	t_R		t_{RC}^{*1}	—	—	ns

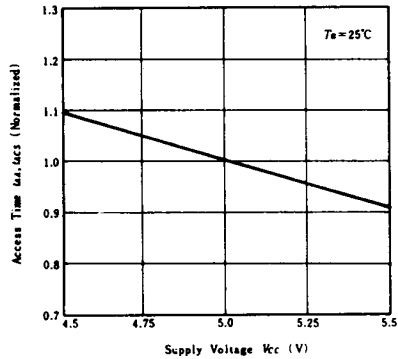
Note) *1. t_{RC} = Red Cycle Time.

● LOW V_{CC} DATA RETENTION WAVEFORM

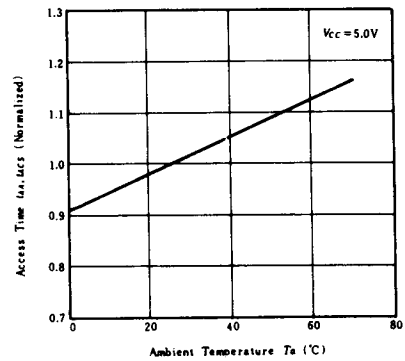


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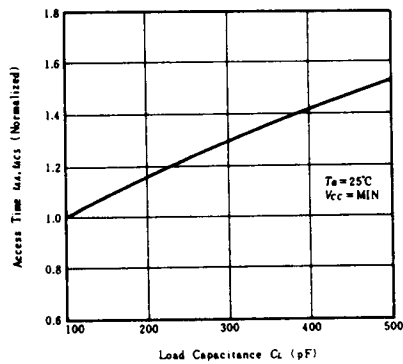
ACCESS TIME VS. SUPPLY VOLTAGE



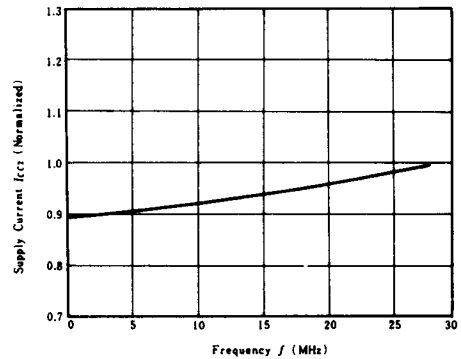
ACCESS TIME VS. AMBIENT TEMPERATURE



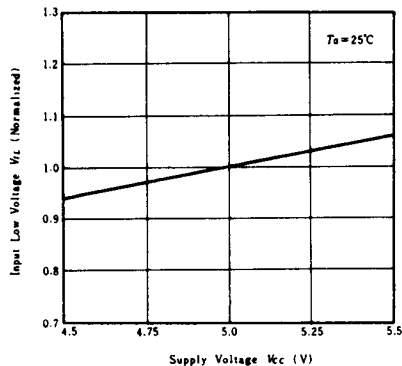
ACCESS TIME VS. LOAD CAPACITANCE



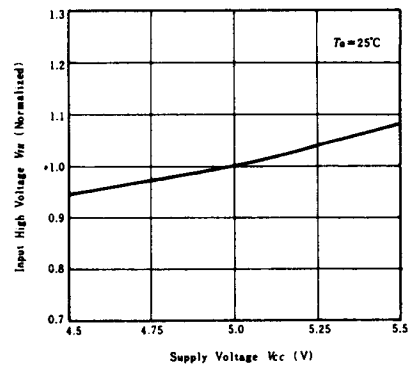
SUPPLY CURRENT VS. FREQUENCY



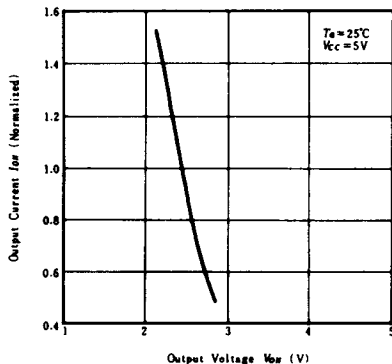
INPUT LOW VOLTAGE VS. SUPPLY VOLTAGE



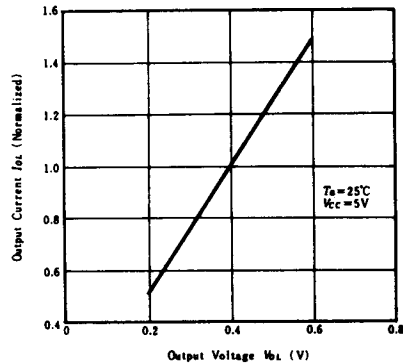
INPUT HIGH VOLTAGE VS. SUPPLY VOLTAGE



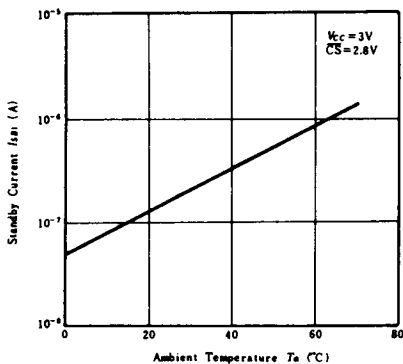
OUTPUT CURRENT VS. OUTPUT VOLTAGE



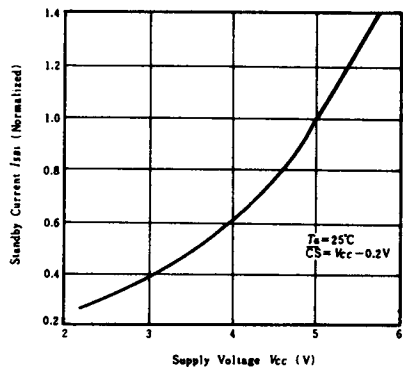
OUTPUT CURRENT VS. OUTPUT VOLTAGE



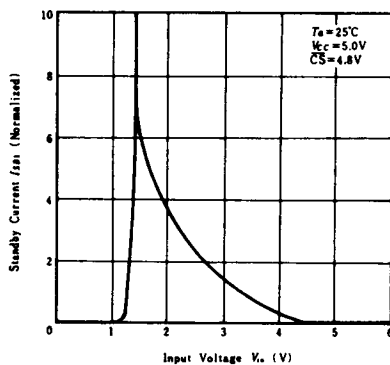
STANDBY CURRENT VS. AMBIENT TEMPERATURE



STANDBY CURRENT VS. SUPPLY VOLTAGE



STANDBY CURRENT VS. INPUT VOLTAGE



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